



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Art Unit: 1765  
Examiner: Lan Vinh

**In re PATENT APPLICATION of:**

Applicant : Toyokazu SAKATA )  
Serial No. : 10/721,260 )  
Filed : November 26, 2003 ) **AMENDMENT**  
For : ETCHING METHOD AND )  
SEMICONDUCTOR DEVICE )  
FABRICATING METHOD )  
Attorney Ref. : TAI 145 )

August 25, 2006

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of May 25, 2006, the period for reply to which has been set to expire on August 25, 2006.

A fee of \$ Now is being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.

**FEE ENCLOSED:\$**  
**Please check for any further**  
**fee to close the deposit Account**  
**No. 1000-2**